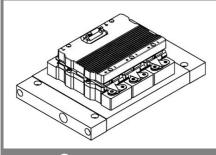
### SKiiP 603GD122-3DUW



## SKiiP® 3

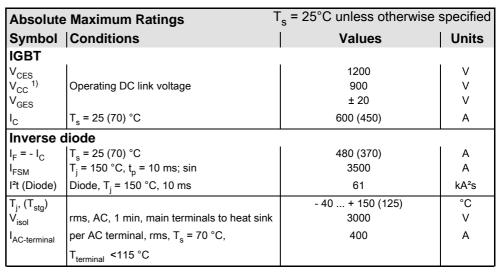
## 6-pack-integrated intelligent Power System

### Power section SKiiP 603GD122-3DUW

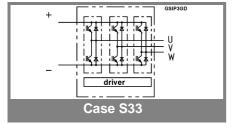
Data

#### **Power section features**

- SKiiP technology inside
- SPT (Soft Punch Through) IGBTs
- CAL diode technology
- · Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP<sup>®</sup> 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized File no. E63532
- with assembly of suitable MKP capacitor per terminal

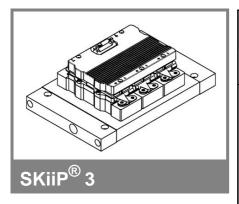


Characteristics				$T_s = 25$ °C unless otherwise specified					
	Conditions				min.	typ.	max.	Units	
IGBT						٠, ۲			
V <sub>CEsat</sub>	I <sub>C</sub> = 300 A measured at	A, T <sub>j</sub> = 25 (1 terminal	125) °C;			2,3 (2,5)	2,6	٧	
V <sub>CEO</sub> r <sub>CE</sub> l <sub>CES</sub>	$T_i = 25 (12)$	25) °C; at t 25) °C; at t ', V <sub>CE</sub> = V <sub>C</sub> 25) °C	erminal			1,1 (1) 3,8 (5) 1,2 (36)	1,3 (1,2) 4,5 (5,6)	V mΩ mA	
E <sub>on</sub> + E <sub>off</sub>		A, V <sub>CC</sub> = 60	0 V			mJ			
	T <sub>j</sub> = 125 °	T <sub>i</sub> = 125 °C, V <sub>CC</sub> = 900 V				159			
R <sub>CC+EE</sub> , L <sub>CE</sub>	top, bottor	terminal chip, T <sub>j</sub> = 25 °C top, bottom			0,5 12			mΩ nH	
C <sub>CHC</sub>	per phase	, AC-side				1		nF	
Inverse o	I <sub>F</sub> = 300 A measured at		25) °C			1,8 (1,5)	2,3	V	
V <sub>TO</sub> r <sub>T</sub> E <sub>rr</sub>	_	25) °C 25) °C A, V <sub>CC</sub> = 60 C, V <sub>CC</sub> = 9				1 (0,7) 2,6 (2,8) 24 31	1,2 (0,9) 3,5 (3,7)	V mΩ mJ mJ	
Mechani	cal data								
M <sub>dc</sub> M <sub>ac</sub> w	AC termin	nals, SI Uni nals, SI Uni System w/c	ts		6 13	2,4	8 15	Nm Nm kg	
w	heat sink					5,2		kg	
Thermal characteristics (NWK40; 8l/min; 50%glyc.); "s" reference to heat sink; "r" reference to built-in temperature sensor								heat	
$R_{th(j-s)I}$	per IGBT						0,051	K/W	
$R_{th(j-s)D}$	per diode						0,1	K/W	
Z <sub>th</sub>	R <sub>i</sub> (mK/W) (max. values)			1					
_	1	2	3	4	1	2	3	4	
$Z_{th(j-r)I}$ $Z_{th(j-r)D}$	4,2 7,8	20,4 12	23,4 53,1	0 53,1	69 50	0,35 5	0,02 0,25	1 0,04	
Z <sub>th(r-a)</sub>	4,6	4,7	1,1	0,6	48	15	2,8	0,35	



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## SKiiP 603GD122-3DUW



# 6-pack-integrated intelligent Power System

6-pack integrated gate driver SKiiP 603GD122-3DUW

Data

#### **Gate driver features**

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformer
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings	a = 25°C unless otherwise specified		
Symbol	Conditions	Values	Units	
$V_{S2}$	unstabilized 24 V power supply	30	V	
$V_{i}$	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
$V_{isollO}$	input / output (AC, rms, 2s)	3000	V	
V <sub>isoIPD</sub>	partial discharge extinction voltage, rms, Q <sub>PD</sub> ≤10 pC;	1170	V	
V <sub>isol12</sub>	output 1 / output 2 (AC, rms, 2s)	1500	V	
f <sub>sw</sub>	switching frequency	15	kHz	
f <sub>out</sub>	output frequency for I <sub>peak(1)</sub> =I <sub>C</sub>	15	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 <b>+</b> 85	°C	

Characte	eristics	(T <sub>a</sub>			= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
$V_{S2}$	supply voltage non stabilized	13	24	30	V
I <sub>S2</sub>	V <sub>S2</sub> = 24 V	365+30*f/kHz+0,00111*(I <sub>AC</sub> /A) <sup>2</sup>			mA
V <sub>iT+</sub>	input threshold voltage (High)			12,3	V
$V_{iT-}$	input threshold voltage (Low)	4,6			V
R <sub>IN</sub>	input resistance		10		kΩ
C <sub>IN</sub>	input capacitance		1		nF
t <sub>d(on)IO</sub>	input-output turn-on propagation time		1,3		μs
t <sub>d(off)IO</sub>	input-output turn-off propagation time		1,3		μs
tpERRRESET	error memory reset time	9		μs	
t <sub>TD</sub>	top / bottom switch interlock time		3		μs
I <sub>analogOUT</sub>	max. 5mA; 8 V corresponds to 15 V supply voltage for external components		500		Α
I <sub>s1out</sub>	max. load current			50	mA
I <sub>TRIPSC</sub>	over current trip level (I <sub>analog</sub> OUT = 10 V)		625		Α
$T_tp$	over temperature protection	110		120	°C
U <sub>DCTRIP</sub>	U <sub>DC</sub> -protection ( U <sub>analog OUT</sub> = 9 V);		900		V
	(option for GB types)				

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